

# Antenna

# YC0009AA Datasheet

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# About the Document

## Revision History

| Version | Date       | Author    | Note                                    |
|---------|------------|-----------|-----------------------------------------|
| -       | 2020-09-20 | Kenny YIN | Creation of the document                |
| 1.0     | 2020-09-20 | Kenny YIN | First official release                  |
| 1.1     | 2021-01-12 | Kenny YIN | Updated the antenna image in Chapter 2. |

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## 1 Product Description

The antenna is designed for superior performance, and can be widely used for wireless applications.

We provide comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs.

## 2 Product Features

- Wi-Fi/BT
- High efficiency
- Excellent performance



### 3 Product Specifications

#### Passive Electrical Specifications

|                   |               |
|-------------------|---------------|
| Frequency Range   | 2400–2500 MHz |
| Input Impedence   | 50 $\Omega$   |
| Return Loss       | $\leq 2.0$    |
| Gain              | 4 .08dBi      |
| Polarization Type | Linear        |

#### Mechanical Specifications

|                     |                          |
|---------------------|--------------------------|
| Antenna Size        | 3.2 mm × 1.6 mm × 0.5 mm |
| Casing              | -                        |
| Radiator            | Ceramic patch            |
| Connector Type      | SMD                      |
| Working Temperature | -40 °C to +85 °C         |
| Radome Color        | -                        |

## 4 Overall Performance

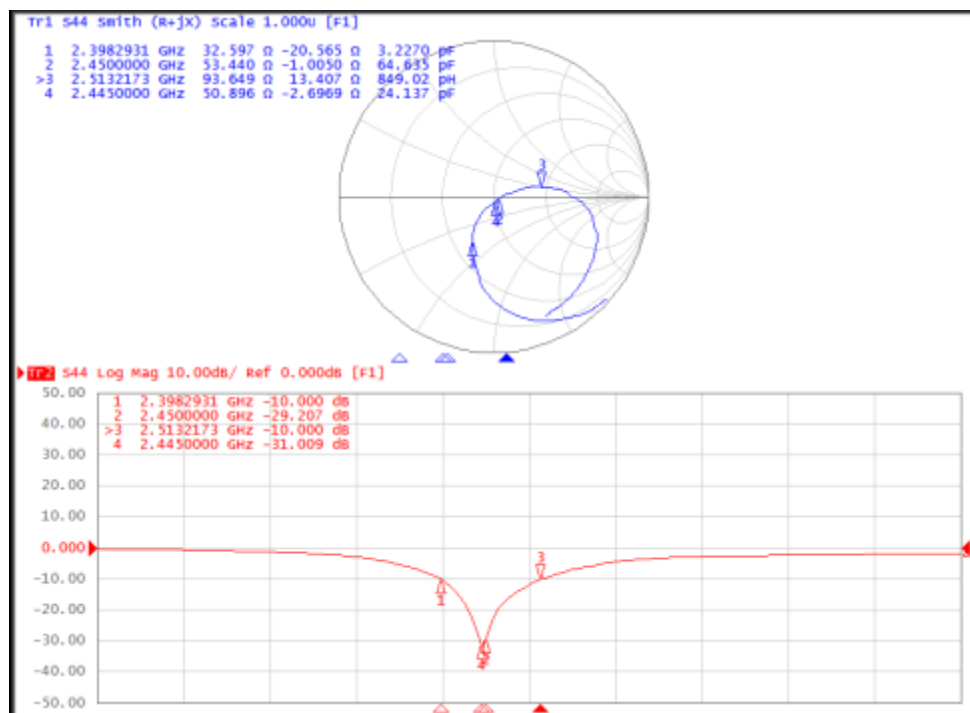
### 4.1. Test Environment

- KEYSIGHT VNA Network Analyzer E5063A, 100 kHz – 6.5 GHz
- RayZone® 2800 Chamber 5G (FR1) SISO/MIMO, 400 MHz – 6.0 GHz





## 4.2. Return Loss



| Frequency (MHz) | 2390 | 2450  | 2513 |
|-----------------|------|-------|------|
| Return Loss     | -10  | -29.2 | -10  |

## 4.3. Efficiency

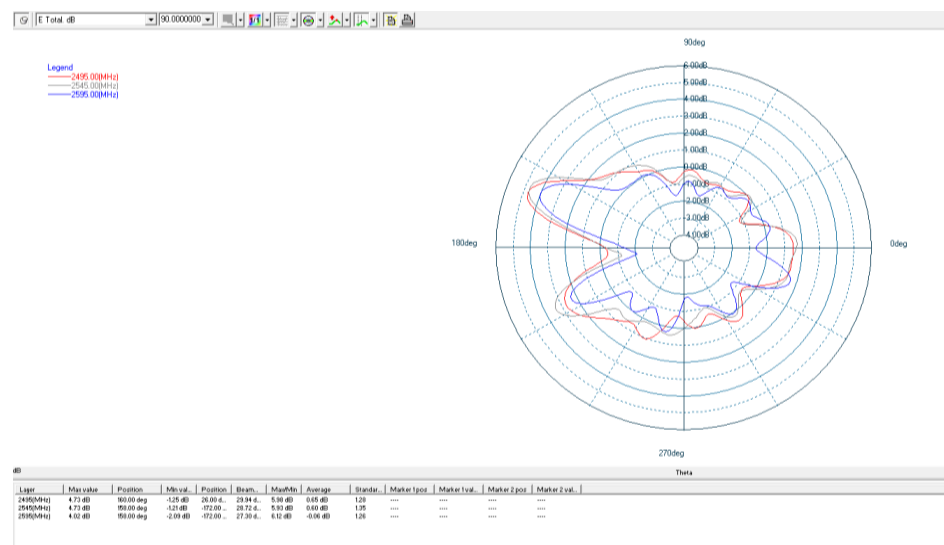
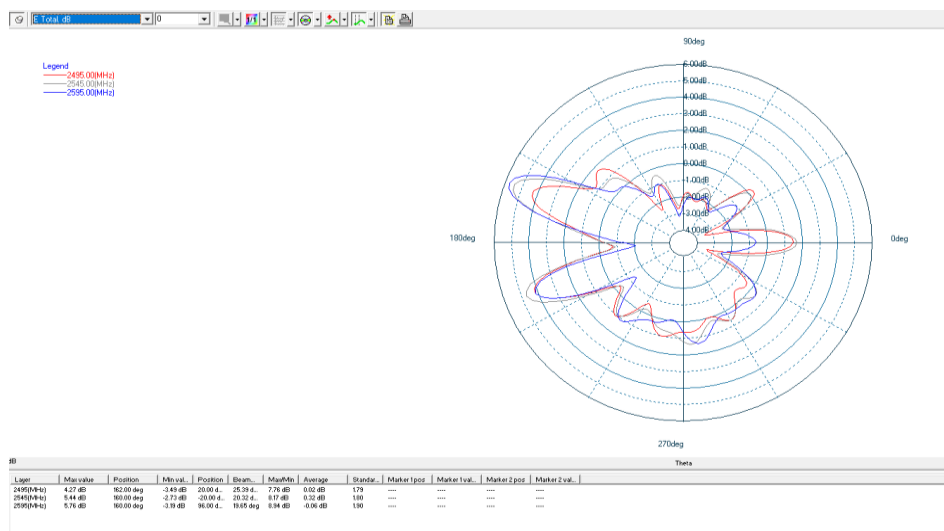
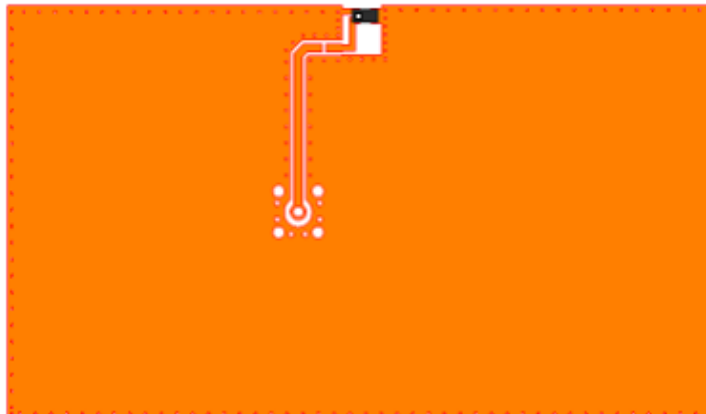
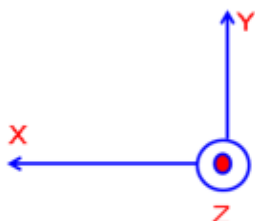
| Frequency (MHz) | 2400 | 2450 | 2500 |
|-----------------|------|------|------|
| Efficiency (%)  | 72.1 | 78.2 | 71.8 |

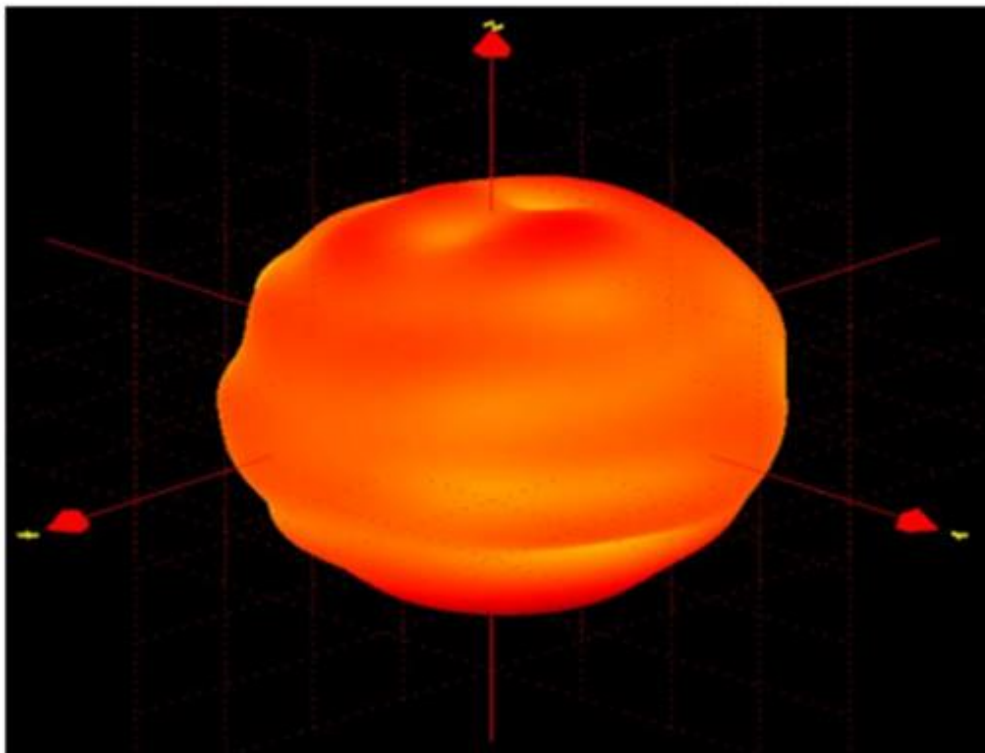
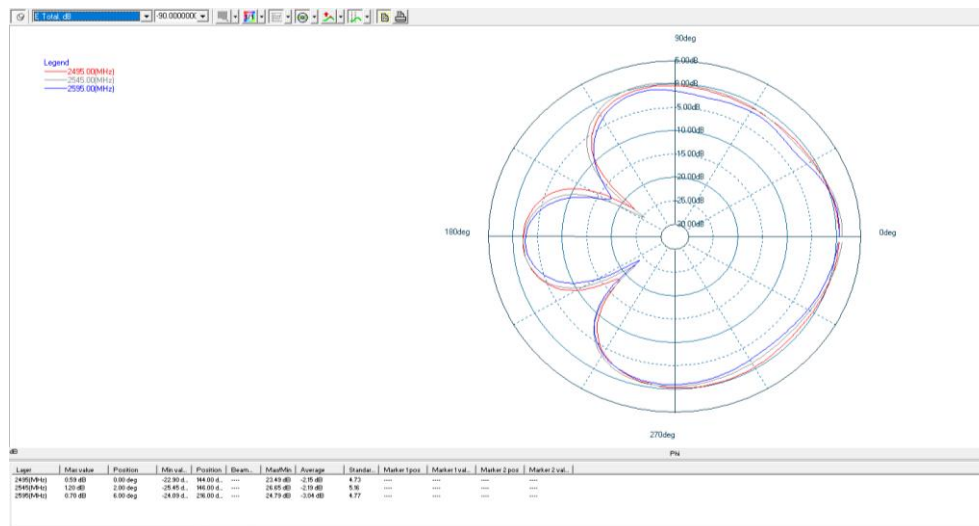
## 4.4. Gain

| Frequency (MHz) | 2400 | 2450 | 2500 |
|-----------------|------|------|------|
| Gain            | 1.76 | 4.08 | 2.53 |

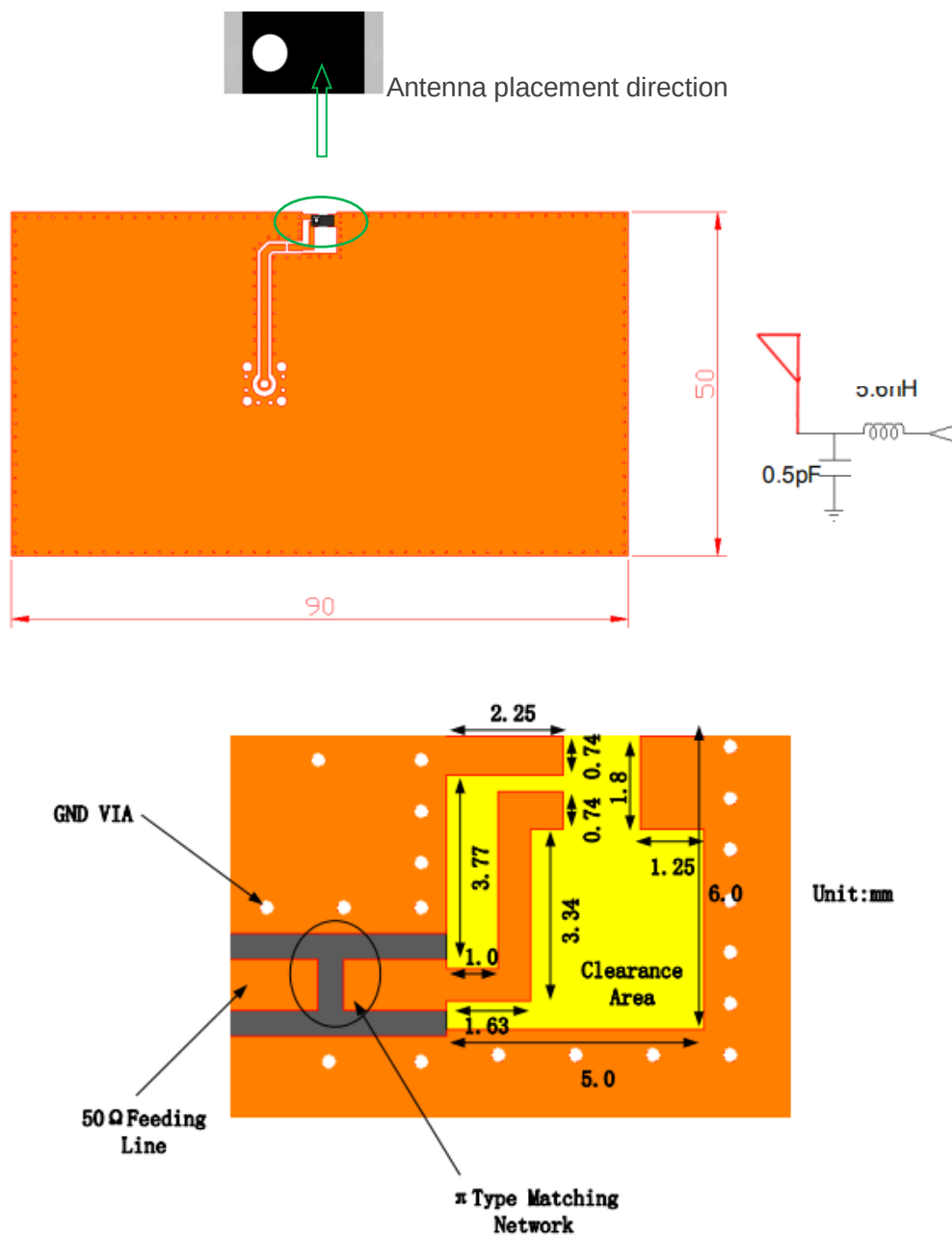
## 4.5. Radiation Patterns

coordinates:

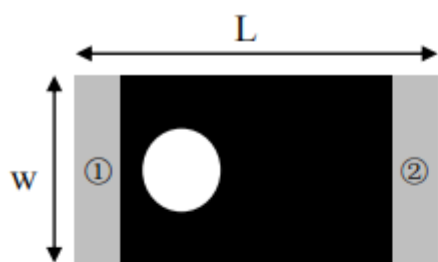




#### 4.6. Reference PCB Design (Unit: mm)

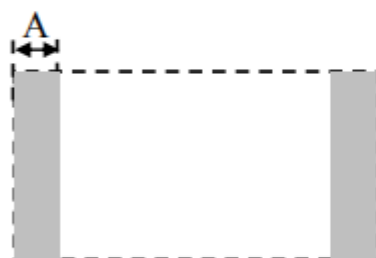


## 5 Product Size



( Top View )

| Number | Terminal Name |
|--------|---------------|
| ①      | INPUT         |
| ②      | NC            |



( Bottom View )



( Side View )

| Symbols    | L         | W         | T         | A         |
|------------|-----------|-----------|-----------|-----------|
| Dimensions | 3.2+/-0.2 | 1.6+/-0.2 | 0.5+/-0.1 | 0.4+/-0.1 |

## 6 Reliability Test

|                             |                  |
|-----------------------------|------------------|
| Temperature Range           | 25 ±5 °C         |
| Relative Humidity Range     | 55–75 %          |
| Operating Temperature Range | -40 °C to +85 °C |
| Storage Temperature Range   | -40 °C to +85 °C |

### 6.1. Vibration Resist

The device should fulfil the electrical specification after being applied to the vibration of 10–55 Hz with amplitude of 1.5 mm for 2 hours in X, Y and Z directions respectively.

### 6.2. Drop Shock

The device should have no mechanical damage after dropping onto the hard wooden board from the height of 100 cm for 3 times at each facet of the 3 dimensions of the device.

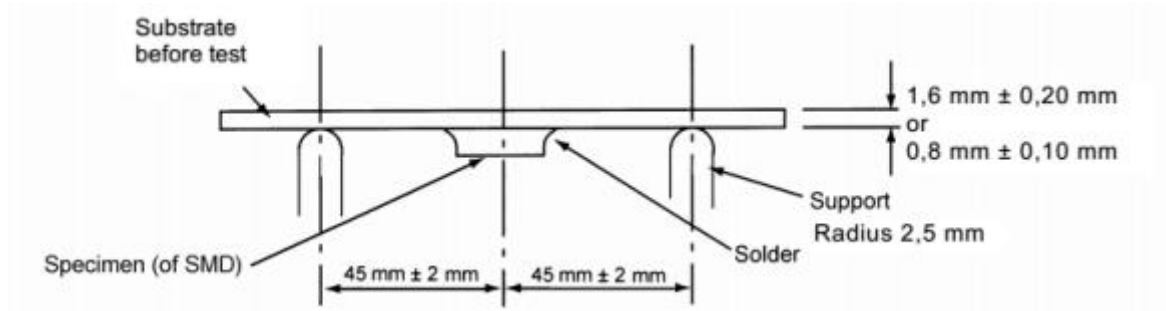
### 6.3. Resistance to Soldering Heat

The device should have no damage after pre-heating at 120–150 °C for 120 seconds and immersion in solder Sn at 255 °C ±10 °C for 5 ±0.5 seconds, or electric iron at 300 °C ±10 °C for 3 ±0.5 seconds.

### 6.4. Adhesive Strength of Termination

The device have no remarkable damage or removal of the termination after horizontal force of 5 N ( $\leq$  0603); 10 N ( $>$  0603) for 10 ±1 seconds.

## 6.5. Bending Resist Test



Weld the product to the central part of the PCB with the thickness  $1.6 \pm 0.2$  mm or  $0.8 \pm 0.1$  mm as the illustration shows, and keep exerting force arrow-ward on it at speed of 1 mm/s, and hold for  $5 \pm 1$  s at the position of 1.5 mm bending distance, so far, any peeling-off of the product metal coating should not be detected.

## 6.6. Moisture Proof

The device should fulfil the electrical specification after being exposed to the temperature  $60 \pm 2$  °C and the relative humidity 90–95 % for 96 hours and 1–2 hours recovery time under normal condition.

## 6.7. High Temperature Endurance

The device should fulfil the electrical specification after being exposed to temperature  $85 \pm 5$  °C for  $96 \pm 2$  hours and 1–2 hours recovery time under normal temperature.

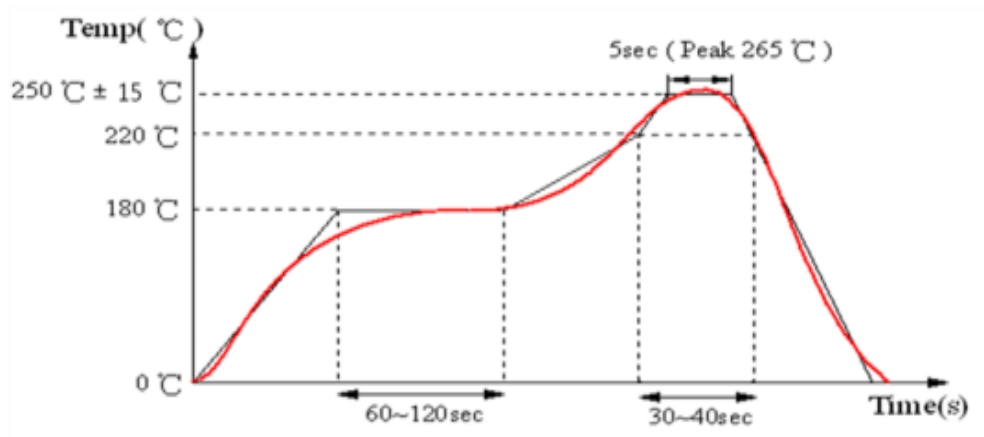
## 6.8. Low Temperature Endurance

The device should fulfil the electrical specification after being exposed to the temperature  $-40$  °C  $\pm 5$  °C for  $96 \pm 2$  hours and to 2 hours recovery time under normal temperature.

## 6.9. Temperature Cycle Test

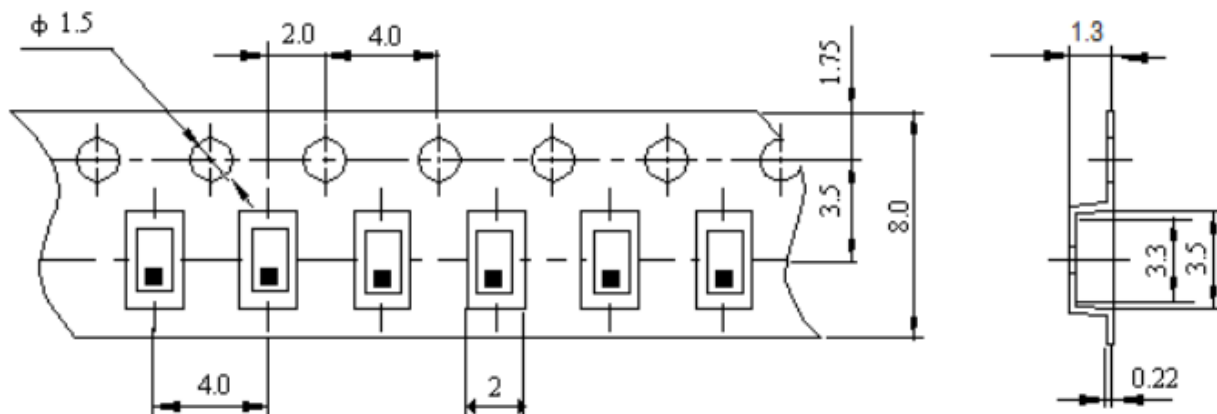
The device should fulfil the electrical specification after being exposed to the low temperature  $-40$  °C and high temperature  $+85$  °C for  $30 \pm 2$  min each by 5 cycles and 1 to 2 hours recovery time under normal temperature.

## 7 Reflow Soldering Standard Condition



## 8 Packaging and Dimensions

### 8.1. Plastic Tape

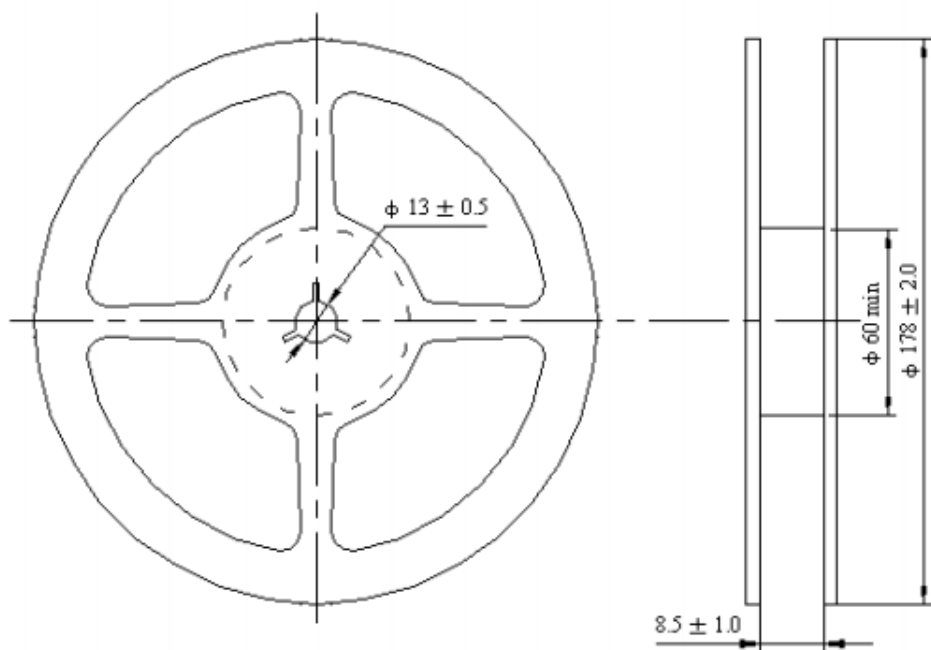


Remarks for Package:

Reserve a length of 150–200 mm for the trailer of the carrier and 250–300 mm for the leader of the carrier and further 250 mm of cover tape at the leading part of the carrier.



## 8.2. Reel (3000 pcs/reel)



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